

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Bing Li</td> <td>07/10/2013</td> </tr> <tr> <td>Sung Mun Jung</td> <td>07/23/2013</td> </tr> <tr> <td>Yi Tat Lim</td> <td>07/23/2013</td> </tr> </tbody> </table>		Name	Execution Date	Bing Li	07/10/2013	Sung Mun Jung	07/23/2013	Yi Tat Lim	07/23/2013		
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<table border="1"> <tr> <td>Name:</td> <td>GLOBALFOUNDRIES Singapore Pte. Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>60 Woodlands Industrial Park D Street 2</td> </tr> <tr> <td>City:</td> <td>Singapore</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>738406</td> </tr> </table>		Name:	GLOBALFOUNDRIES Singapore Pte. Ltd.	Street Address:	60 Woodlands Industrial Park D Street 2	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	738406
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CORRESPONDENCE DATA											
Fax Number: 4803855061 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 4803855060 Email: mbartnek@ifllaw.com Correspondent Name: INGRASSIA FISHER & LORENZ, P.C. Address Line 1: 7010 E. Cochise Road Address Line 4: Scottsdale, ARIZONA 85253											
ATTORNEY DOCKET NUMBER:	126.0011 (DSG120)										
NAME OF SUBMITTER:	Ryan T. Fortin										
Signature:	/Ryan T. Fortin/										
Date:	08/06/2013										

OP \$40.00 13955637

This document serves as an Oath/Declaration (37 CFR 1.63).

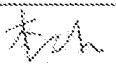
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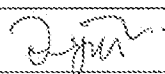
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COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	METHODS FOR FABRICATING INTEGRATED CIRCUITS WITH A HIGH-VOLTAGE MOSFET
DECLARATION	
As the below named inventor, I hereby declare that:	
This declaration is directed to: ☒ The attached application, or ☐ United States application or PCT international application number _____ filed on _____	
The above-identified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.	
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	
I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.	
ASSIGNMENT	
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications; the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.	
If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.	
LEGAL NAME OF INVENTOR	
Inventor:	Li Bing
Date:	July 10, 2013
Signature:	
Note: An application data sheet (PTO/EE/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.	

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LEGAL NAME OF INVENTOR Inventor: <u>LIM YI TAT</u> Date: <u>23 JULY 2012</u> Signature: <u></u>	
Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.	

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LEGAL NAME OF INVENTOR	
Inventor: <u>JUNG SANG MUN</u>	Date: <u>23 JULY 2013</u>
Signature: <u>[Handwritten Signature]</u>	
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